

### SPECIFICATION FOR LCM MODULE

### MODULE NO.: ABG128064A15-BIW-R DOC. REVISION 00

**Customer Approval:** 

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
PREPARED BY (QA ENGINEER)		
CHECKED BY		
APPROVED BY		



### **DOCUMENT REVISION HISTORY**

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00	Mar-19-2007	First issue	



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### **<u>1. FUNCTIONS & FEATURES</u>**

- 1.1. Format
- 1.2. LCD mode
- 1.3. Viewing direction
- 1.4. Driving scheme
- 1.5. Power supply voltage ( $V_{DD}$ )
- 1.6. LCD driving voltage
- 1.7. Operation temp
- 1.8. Storage temp
- 1.9. Backlight color
- 1.10 Control IC
- 1.11.RoHS standard

- : 128x64dots
- : STN / Negative Transmissive Mode /Blue
- : 6 o'clock
- : 1/64 Duty cycle, 1/6 Bias
- : 5.0V
- : 8.0V : -20~70°C
- : -20~70℃ : -30~80℃
- : -30~80 : White
- : S6B0108B

### 2. MECHANICAL SPECIFICATIONS

- 2.1. Module size
- 2.2. Viewing area
- 2.3. Dot pitch
- 2.4. Dot size
- 2.5. Weight

- : 93.0mm(L)\*70.0mm(W)\*13.8 max mm (H)
- : 70.7mm(L)\*38.8mm(W)
- : 0.52mm(L)\*0.52mm(W)
- : 0.48mm(L)\*0.48mm(W)
- : Approx.

### **3. BLOCK DIAGRAM**

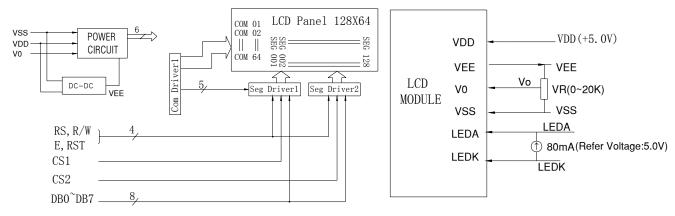


Figure 1. Block diagram

1

### 4. DIMENSIONAL OUTLINE

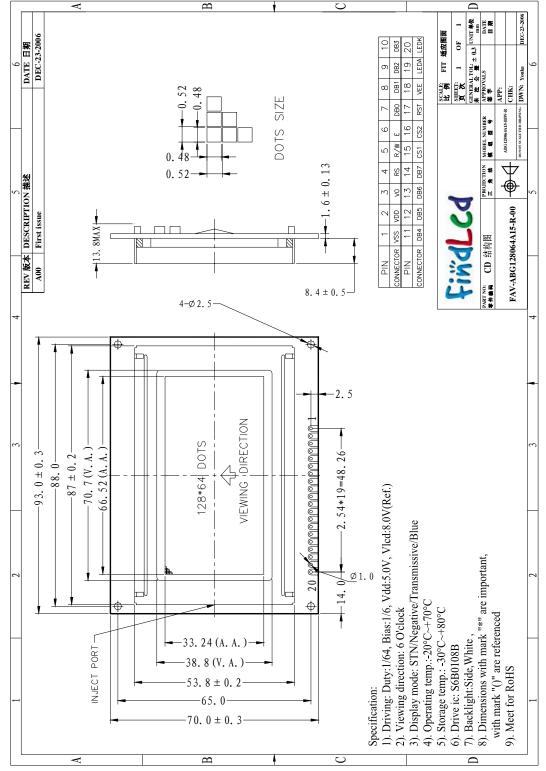


Figure 1. Dimensional outline

CUSTOMER CO	)RD	CUSTO	MER NAME					NO.		Revis	ion Record			Reviser Metthew	Date 05/09/01
						,	,	2.	A	修改FPC尺寸	1			Metthew	05/12/22
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49.65±0.2 38.8 V.A. 33.24 A.A.		Y.A. A.A.		<u>35±0.15</u> TO FILM~						YL	YR XH YR XL 2 3 4	AM	1 2 3	UT ESC XH YL XL YR	
							·					COLOURI	04.10	1000	0101102 0000
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			36					Trees the	1.F	esistance	Direction"X*(	Flim):200	~900Ω	rhiti	. ciere ijpe
78					`		00		b	etween Lead	Direction"Y*(	Glass):20	0~900Ω		
		1				LITO GLA	22	Electrical	2.1	inearity	Direction"X":				
10								Spec		•	Direction"Y*:			2	
I FI										nsulation R Thattering Time	20MΩ or more 10msec or les				
11 11 11 11 11 11 11 11 11 11 11 11 11	5										A Special Sty				
20-0.		ł						Mechanica			Stylus:80g or	less(RO.	8 Polyaceta		
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	100		SU	PPORT BOARD	$\sqrt{r^{00}}$	NDUCTIVE FAC	CE			urface Hardness	3H or more(ac				
D_1*2	-3 0+0 1 LIN 1				¥V				2.1	igh Temp Test ow Temp Test	80°C for 240 hou -40°C for 240 ho				r 24 hours, sure it & satisfy
<u>r=1*3</u>	=3.0±0.1	0.5			0	3±0.05		Reliability			60°C, 90%RH fo				trical Spec 1,2,3.
	₩=0.6*4	0				5-0.05					-30'C for 60min			lcs)	
	- sto 1 the VB	$\overline{\Delta}_{10}$								and Writing	Write 120000 ca	pital in 20m	mX20mm		sure it & satisfy
	<u>5±0.1</u>	$\triangleleft$						Durability		iction Resistance unching Life	(force:250g, spe Punch 10000006 rubber(force:250	mes with Ri	0.8silicon	Elec	trical Spec 1,2,3.
	h-									PC celing Strength	400g/cm or more in direction of X	(peeling up	ward by 90°		
Elucidation	總成圖	Drive Model	Analog	Approved By	蔡明樹	05/07/	/ 21						2.2	Pro 4	
Panel Size	79.2X 49.65mm	Drive Valtage		Checked By	蔡明樹		/ 21		G	www.FindLC emini Technol		L		(3) Model 1	T -
Viewing Size	70.7X38.8 mm	Operating Temp	-20~60°C	Design By	X.W.H	05 / 07 /	/ 21	Te	1:03	1-455-3200.	Fax: 031-42	29-7097		PQ07	0XRA
Front Material/Thickness	Transparent Pet(3H)/0.188mm	Storage Temp	-40~60°C	Drawing By	X.W.H	05 / 07 /	/ 21	Sheet	1/1	Tolerance	±0.2	Unit	mm	Drawing	Number
Rear Material/Thickness	Glass / 1.1mm	Connector	FPC(Polymide)	Data Reserve	D:\DWG\PQ0	70XRA\PQ070XR	A.DWG	Size	A4	Angles	±0.5°	Scale		PQ070	XRA03

### **5. PIN DESCRIPTION**

No.	Symbol	Function
1	VSS	GND
2	VDD	Logic supply voltage (+5.0V)
3	V0	Power supply for LCD
4		Data/Instruction
	RS	RS=high: Indicates that data of DB0~DB7 is display data.
		RS=low: Indicates that data of DB0~DB7 is instruction
5		Read/Write
	R/W	R/W=high : Data of DB0~DB7 can be read by CPU.
	IV/ VV	R/W=low: Data of DB0~DB7 can be written into LCD driver IC at the
		falling edge of E when CS1 and CS2 is high.
6	E	Enable signal for LCM
7~14	DB0-DB7	Data Bus line
15	CS1	Chip select(High select left panel)
16	CS2	Chip select(High select right panel)
17	RST	Reset Signal, low level of RST is for reset and keep RST='h'
18	VEE	Output of supply negative voltage by the DC-DC converter on the module
19	LEDA	Power supply for backlight(+)
20	LEDK	Power supply for backlight(-)

### 6. MAXIMUM ABSOUTE LIMIT

Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	Vdd	-0.3	7.0	V
Supply Voltage for LCD	V0	Vdd-19.0	VDD+0.3	V
Input Voltage	Vin	-0.3	V <sub>DD</sub> +0.3	V
Supply Current for Backlight	$I_F(Ta = 25^{\circ}C)$		80+80*20%	mA
Reverse Voltage for Backlight	$V_R(Ta = 25^{\circ}C)$		5	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Tst	-30	80	°C



### 7. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD-VSS	$Ta = 25^{\circ}C$	4.75	5.0	5.25	V
Input High Voltage	Vih	$Ta = 25^{\circ}C$	$0.7 V_{DD}$		VDD	V
Input Low Voltage	Vil	$Ta = 25^{\circ}C$	0		0.3Vdd	V
Output High Voltage	Voh	$Ta = 25^{\circ}C$	2.4			V
Output Low Voltage	Vol	$Ta = 25^{\circ}C$			0.4	V
Supply Current	Idd	$Ta = 25^{\circ}C$		5	8	mA

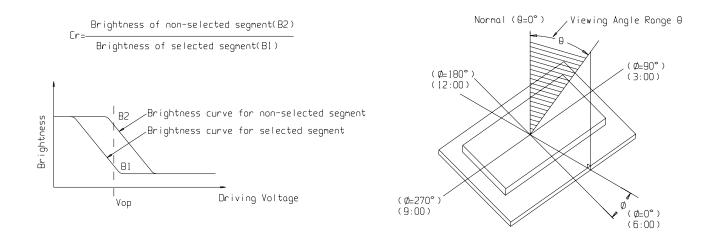
## **8. BACKLIGHT CHARACTERISTICS** $Ta = 25^{\circ}C$

Item	Symbol	Condition	Min	Тур	Max	Unit			
Forward Voltage	VF	IF=80mA	3.0	3.1	3.2	V			
Reverse Current	IR	VR=5V			40	uA			
Luminous Intensity (With	IV	IF=80mA		50		Cd/m <sup>2</sup>			
LCD dots off)									
Wave length(Without LCD)	λρ					nm			
Color	white								

### 9. ELECTRO-OPTICAL CHARACTERISTICS

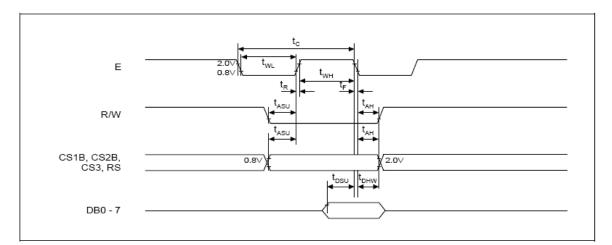
 $\overline{(VDD=5.0V, Ta = 25^{\circ}C)}$ 

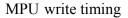
Item	Symbol	Condition	Min	Тур	Max	Unit
		Ta = -20C	8.2	8.5	8.8	
Operating Voltage	Vop	$Ta = 25^{\circ}C$	7.7	8.0	8.3	V
		Ta = 70C	7.2	7.5	7.8	
Posnonso timo	Tr	$Ta = 25^{\circ}C$		185		ms
Response time	Tf	1a - 23C		200		ms
Contrast	Cr	$Ta = 25^{\circ}C$		4		
Viewing angle range	θ	Cr≥2	-40		+40	deg
viewing angle range	Φ	CI≥2	-40		+40	deg

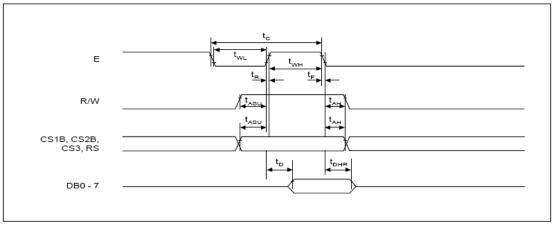


### 10. TIMING CHARACTERISTICS (Please refer SAMSUNG S6B0108 DATASHEES )

Characteristic	Symbol	Min	Тур	Max	Unit
E cycle	t <sub>c</sub>	1000	-	-	ns
E high level width	t <sub>WH</sub>	450	-	-	ns
E low level width	t <sub>WL</sub>	450	-	-	ns
E rise time	t <sub>R</sub>	-	-	25	ns
E fall time	t <sub>F</sub>	-	-	25	ns
Address set-up time	t <sub>ASU</sub>	140	-	-	ns
Address hold time	t <sub>AH</sub>	10	-	-	ns
Data set-up time	t <sub>DSU</sub>	200	-	-	ns
Data delay time	t <sub>D</sub>	-	-	320	ns
Data hold time (write)	t <sub>DHW</sub>	10	-	-	ns
Data hold time (read)	t <sub>DHR</sub>	20	-	-	ns







#### MPU read timing

## **<u>11. CONTROL AND DISPLAY INSTRUCTION</u>**(Please refer SAMSUNG S6B0108 DATASHEES)

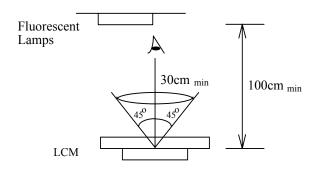
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display on/off	L	L	L	L	Н	н	Н	Н	Н	L/H	Controls the display on or off. Internal status and display RAM data is not affected. L: OFF, H: ON
Set address (Y address)	L	L	L	Н		Y	addres	s (0 - 6	33)		Sets the Y address in the Y address counter.
Set page (X address)	L	L	Н	L	н	н	н	Pa	ige (0 ·	- 7)	Sets the X address at the X address register.
Display start line (Z address)	L	L	Н	Н		Displa	ay star	t line (C	) - 63)		Indicates the display data RAM displayed at the top of the screen.
Status read	L	Н	Busy	L	On / Off	Reset	L	L	L	L	Read status. BUSY L: Ready H: In operation ON/OFF L: Display ON H: Display OFF RESET L: Normal H: Reset
Write display data	Н	L			•	Write	data	•	•	•	Writes data (DB0:7) into display data RAM. After writing instruction, Y address is increased by 1 automatically.
Read display data	Η	Н				Read data					Reads data (DB0: 7) from display data RAM to the data bus.

### **12.QUALITY SPECIFICATIONS**

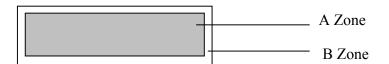
#### 12.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area).

B Zone: Non-active display area (outside viewing area).

#### 12.2 Specification of quality assurance

AQL inspection standard

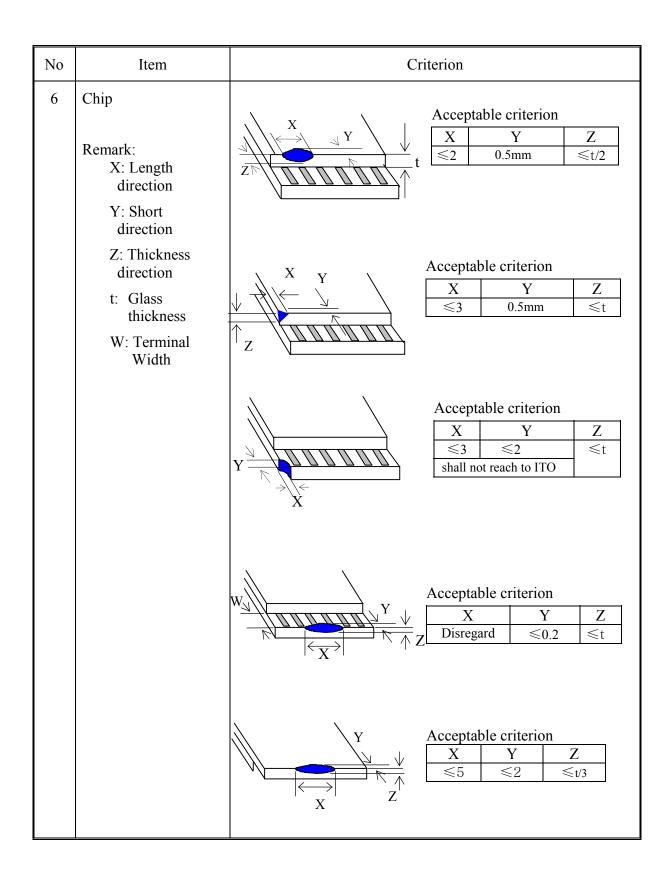
Sampling method: MIL-STD-105E, Level II, single sampling

#### Defect classification (Note: \* is not including)

Classify		Item	Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display	Background color deviation	2	1.0
	state	Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
		Protruded	12	
	Polarizer	Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

#### Note on defect classification

No.	Item	Criterion					
1	Short or open circuit	Not allow					
	LC leakage						
	Flickering						
	No display						
	Wrong viewing direction						
	Wrong Back-light						
2	Contrast defect	Refer to approval sample					
	Background color deviation						
3	Point defect, Black spot, dust	Ŷ			Point Size	Acceptable Qty.	
	(including Polarizer)	'X'		0	<u>φ≤</u> 0.10 .10<φ≤0.20	Disregard 3	
					.10<¢≤0.20 .20<¢≤0.25	2	
	$\phi = (X+Y)/2$				.25<¢≤0.30	1	
				φ>0.30		0	
		Unit: mm					
4	Line defect,						
	Scratch		Ŧ		Line	Acceptable Qty.	
			L		W 0.015≥W	Disregard	-
			5.0≥		0.03≥W	2	_
			5.0≥		0.05≥W		
			5.0≥	εL	0.1>W 0.05 <w< td=""><td>1 Applied as point defect</td><td></td></w<>	1 Applied as point defect	
		Unit: mm					
5	Rainbow	Not more than two color changes across the viewing area.					



No.	Item	Criterion			
7	Segment pattern W = Segment width $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10$ mm is acceptable.			
8	Back-light	<ul> <li>(1) The color of backlight should correspond its specification.</li> <li>(2) Note that a finite state of the stat</li></ul>			
9	Soldering	<ul> <li>(2) Not allow flickering</li> <li>(1) Not allow heavy dirty and solder ball on PCB.</li> <li>(The size of dirty refer to point and dust defect)</li> <li>(2) Over 50% of lead should be soldered on Land.</li> </ul>			
10	Wire	<ol> <li>(1) Copper wire should not be rusted</li> <li>(2) Not allow crack on copper wire connection.</li> <li>(3) Not allow reversing the position of the flat cable.</li> <li>(4) Not allow exposed copper wire inside the flat cable.</li> </ol>			
11*	PCB	<ul> <li>(4) Not allow exposed copper wire inside the flat cable.</li> <li>(1) Not allow screw rust or damage.</li> <li>(2) Not allow missing or wrong putting of component.</li> </ul>			

No	Item	Criterion		
12	Protruded W: Terminal Width	$W_{\underline{y}}$ $W_{\underline{y}$ $W_{\underline{y}}$ $W_{\underline{y}}$ $W_{\underline{y}}$ $W_{\underline{y}}$ $W_{$		
13	ТАВ	1. Position H H H TAB $H = TAB$ $W = W1$ $W1 \le 1/3W$ $H1 \le 1/3H$		
		2 TAB bonding strength test F TAB P (=F/TAB bonding width) $\geq$ 650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)		
14	Total no. of acceptable Defect	<ul> <li>A. Zone</li> <li>Maximum 2 minor non-conformities per one unit.</li> <li>Defect distance: each point to be separated over 10mm</li> <li>B. Zone</li> <li>It is acceptable when it is no trouble for quality and assembly in customer's end product.</li> </ul>		

#### 12.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	No abnormalities
Low temp. Operating	-20°C	48	in functions
Humidity	40°C/ 90%RH	48	and appearance
Temp. Cycle	$-20^{\circ}C \leftarrow 25^{\circ}C \rightarrow 70^{\circ}C$	10cycles	
	$(30 \min \leftarrow 5 \min \rightarrow 30 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance ,etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ( $20\pm8^{\circ}$ C), normal humidity (below  $45\pm20\%$  RH), and in the area not exposed to direct sun light.

#### 12.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

#### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting Gemini.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

#### **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

#### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature:  $280^{\circ}C \pm 10^{\circ}C$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

#### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

#### **Limited Warranty**

Gemini LCDs and modules are not consumer products, but may be incorporated by Gemini's customers into consumer products or components thereof, Gemini does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of Gemini is limited to repair or replacement on the terms set forth below. Gemini will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Gemini and the customer, Gemini will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Gemini general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.